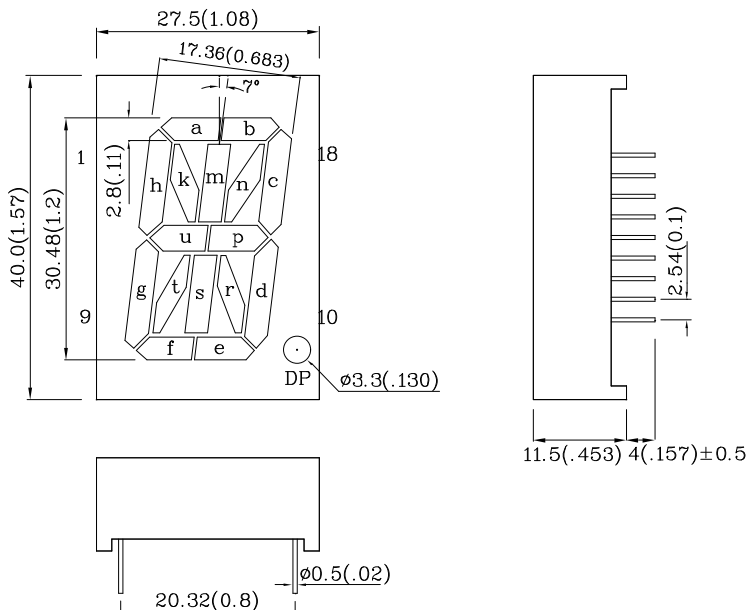
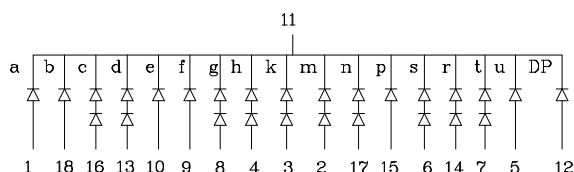


Features

- 1.2 INCH CHARACTER HEIGHT.
- LOW CURRENT OPERATION.
- HIGH CONTRAST AND LIGHT OUTPUT.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- CATEGORIZED FOR LUMINOUS INTENSITY.
- MECHANICALLY RUGGED.
- STANDARD : GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.



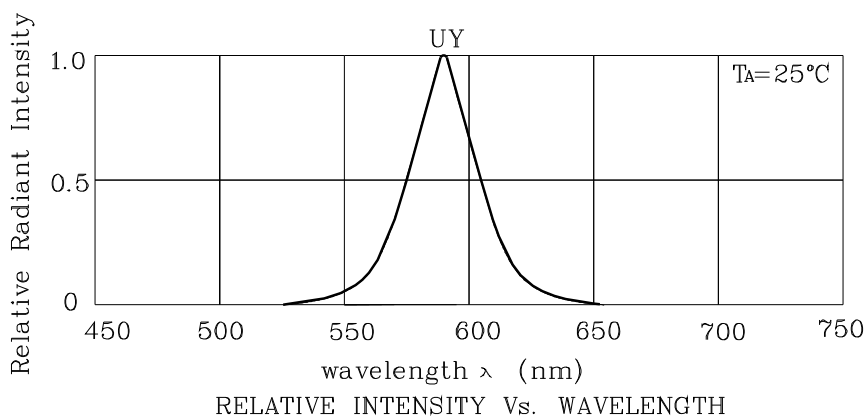
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Specifications are subject to change without notice.

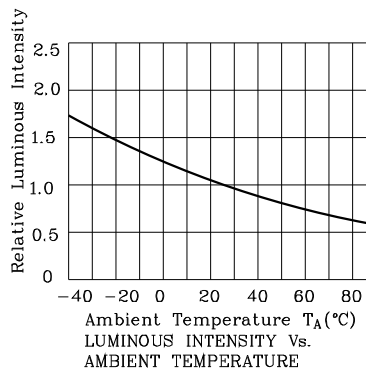
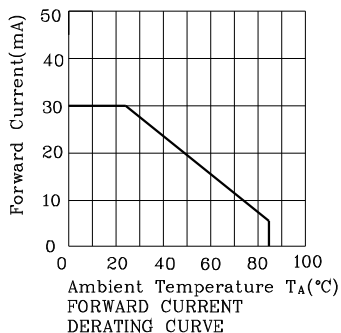
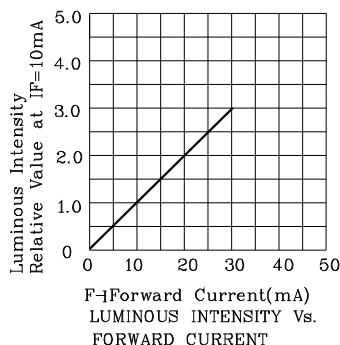
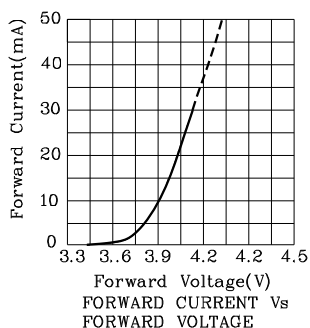
Absolute Maximum Ratings (TA=25°C)			UY (GaAsP/ GaP)	Unit
Reverse Voltage	c,d,g,h,k,m,n, s,r,t	VR	10	V
	a,b,e,f,p,u and DP		5	
DC Forward Current	c,d,g,h,k,m,n, s,r,t	IF	30	mA
	a,b,e,f,p,u and DP			
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	c,d,g,h,k,m,n, s,r,t	iFS	140	mA
	a,b,e,f,p,u and DP			
Power Dissipation	c,d,g,h,k,m,n, s,r,t	PT	150	mW
	a,b,e,f,p,u and DP		75	
Operating Temperature		TA	-40 ~ +85	°C
Storage Temperature		Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]		260°C For 3~5 Seconds		

Operating Characteristics (TA=25°C)			UY (GaAsP/ GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	c,d,g,h,k,m,n ,s,r,t	VF	3.9	V
	a,b,e,f,p,u and DP		1.95	
Forward Voltage (Max.) (IF=10mA)	c,d,g,h,k,m,n ,s,r,t	VF	5	V
	a,b,e,f,p,u and DP		2.5	
Reverse Current (Max.) (VR=10V(5V))	c,d,g,h,k,m,n ,s,r,t	IR	10	uA
	a,b,e,f,p,u and DP			
Wavelength of Peak Emission (Typ.) (IF=10mA)		λ P	590	nm
Wavelength of Dominant Emission (Typ.) (IF=10mA)		λ D	588	nm
Spectral Line Full Width At Half- Maximum (Typ.)(IF=10mA)		Δλ	35	nm
Capacitance (Typ.) (VF=0V, f=1MHz)		C	20	pF

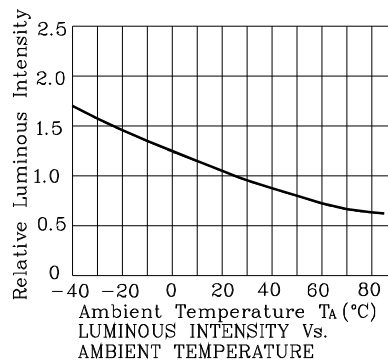
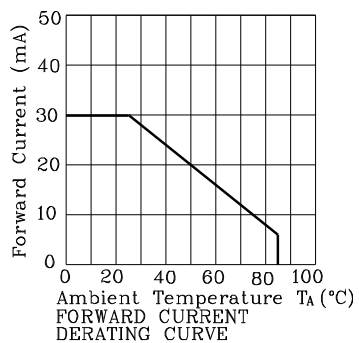
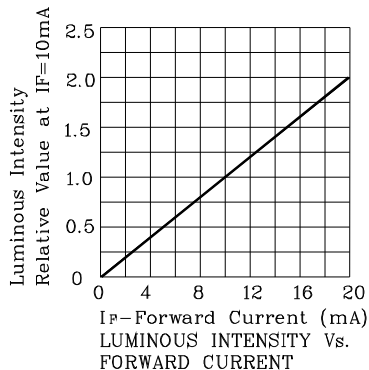
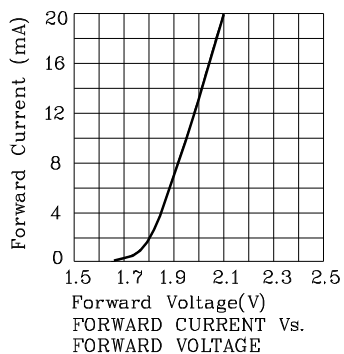
Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm λ_P	Description
			min.	typ.		
AUY30C	Yellow	GaAsP/GaP	1200	4690	590	Common Cathode, Rt. Hand Decimal



❖ UY

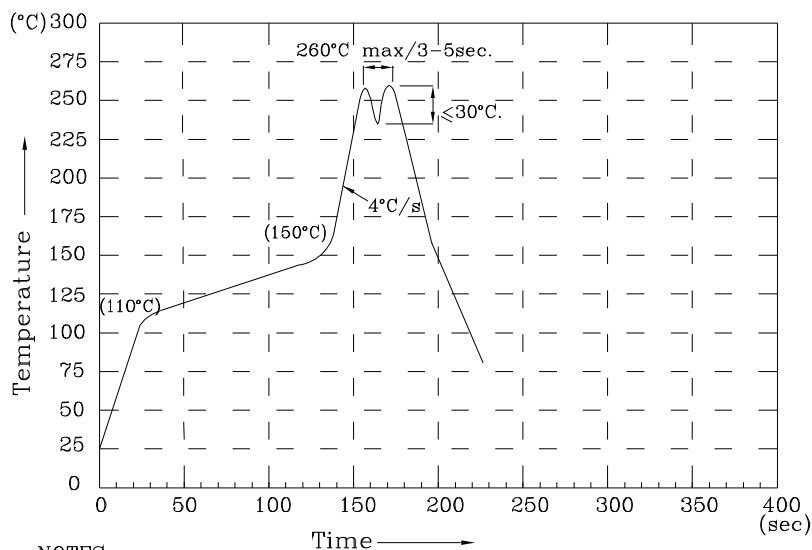


Note: the curves are on the segment c,d,g,h,k,m,n,s,r and t.



Note: the curves are on the segment a,b,e,f,p,u and DP.

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature $245^{\circ}\text{C}\sim 260^{\circ}\text{C}$.The maximum soldering temperature should be less than 260°C .
- 2.Do not apply stress on epoxy resins when temperature is over 85°C .
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.

Remarks:

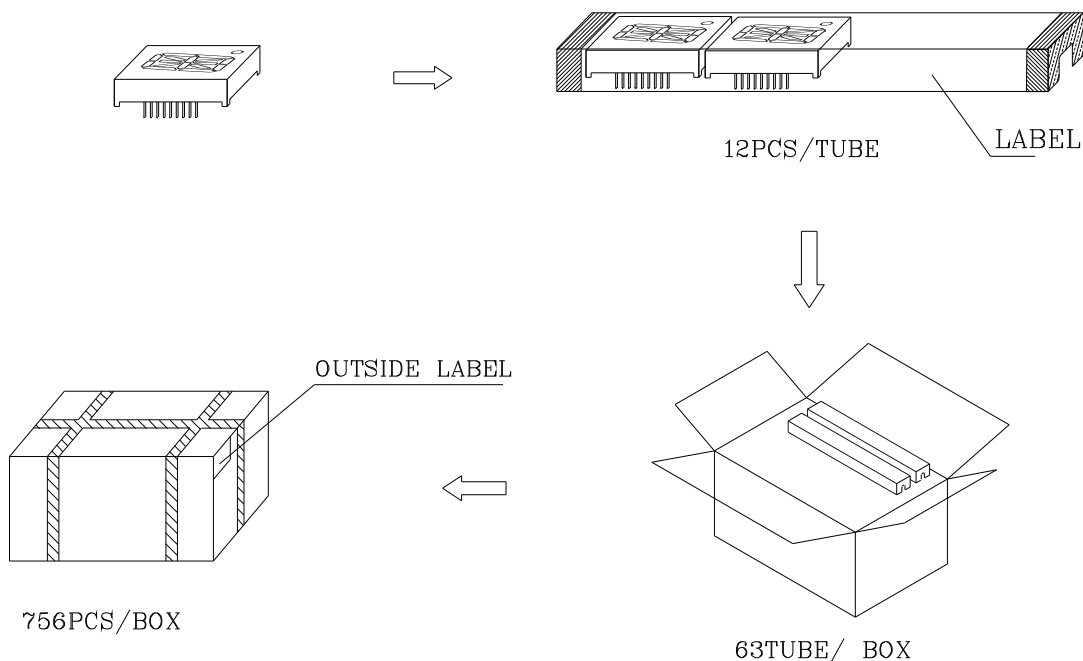
If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous Intensity / Luminous Flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

AUY30C



Inside LABEL Paste On The IC-tube

SunLED	PART NO: Axx30x	Q.C.
QTY: 12 PCS	CODE: xx	PASSED
XXXXXXXXXX-XXXX		xx xx xx
LOT NO.		FQCX
RoHS Compliant		Date
		Number OF FQC

Outside LABEL Paste On The Box

BOX Number	xxxx	xxxx	BIN CODE
Axx30x	756	xx	Number OF QA
QAxx xx xx xx PASSED			Date